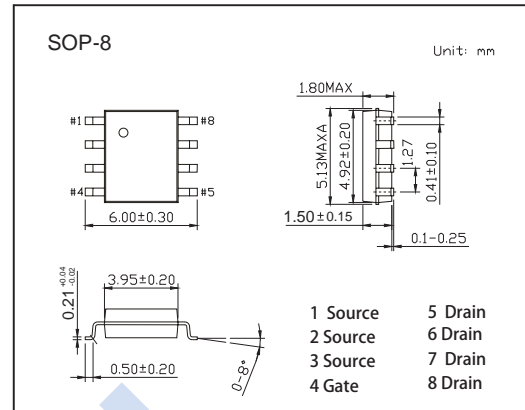
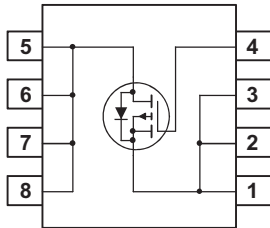


P-Channel MOSFET

KI9435DY

■ Features

- $V_{DS} (V) = -30V$
- $I_D = -5.3 A (V_{GS} = -10V)$
- $R_{DS(ON)} < 58m\ \Omega (V_{GS} = -10V)$
- $R_{DS(ON)} < 89m\ \Omega (V_{GS} = -4.5V)$
- Fast switching speed



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	-5.3	A
Pulsed Drain Current	I_{DM}	-20	
Avalanche Current	I_{AS}	17	
Avalanche Energy (L=0.1mH)	EAS	14	mJ
Power Dissipation (Note.1) (Note.2) (Note.3)	P_D	2.5	W
		1.2	
		1	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	50	$^\circ C/W$
Thermal Resistance.Junction- to-Case	R_{thJC}	25	
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 to 150	

Note.1: $50^\circ C/W$ when mounted on a $1in^2$ pad of 2 oz copper

Note.2: $105^\circ C/W$ when mounted on a $.04in^2$ pad of 2 oz copper

Note.3: $125^\circ C/W$ when mounted on a minimum pad.

P-Channel MOSFET

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■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =-250 μA, V _{GS} =0V	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V			-1	μA
Gate-Body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =-250 μA	-1		-3	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-5.3A (Note.1)			58	mΩ
		V _{GS} =-10V, I _D =-5.3A, T _J =125°C (Note.1)			84	
		V _{GS} =-4.5V, I _D =-4.2A (Note.1)			89	
On state drain current	I _{D(on)}	V _{GS} =-10V, V _{DS} =-5V (Note.1)	-20			A
Forward Transconductance	g _{FS}	V _{DS} =-15V, I _D =-5.3A (Note.1)		12		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-15V, f=1MHz		690		pF
Output Capacitance	C _{oss}			306		
Reverse Transfer Capacitance	C _{rss}			77		
Total Gate Charge	Q _g	V _{GS} =-15V, V _{DS} =-10V, I _D =-5.3A		14	23	nC
Gate Source Charge	Q _{gs}			2.4		
Gate Drain Charge	Q _{gd}			4.8		
Turn-On DelayTime	t _{d(on)}	V _{GS} =-10V, V _{DS} =-15V, I _D =-1A, R _G =6Ω		7	14	ns
Turn-On Rise Time	t _r			10	18	
Turn-Off DelayTime	t _{d(off)}			19	34	
Turn-Off Fall Time	t _f			11	20	
Maximum Body-Diode Continuous Current	I _S				-5.3	A
Diode Forward Voltage	V _{SD}	I _S =-5.3A, V _{GS} =0V (Note.1)			-1.2	V

Note.1: Pulse Test: Pulse Width < 300μs, Duty Cycle < 2.0%

■ Marking

Marking	9435 KC****
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P-Channel MOSFET KI9435DY

Typical Characteristics

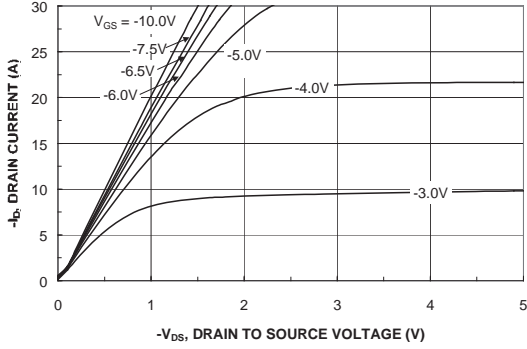


Figure 1. On-Region Characteristics.

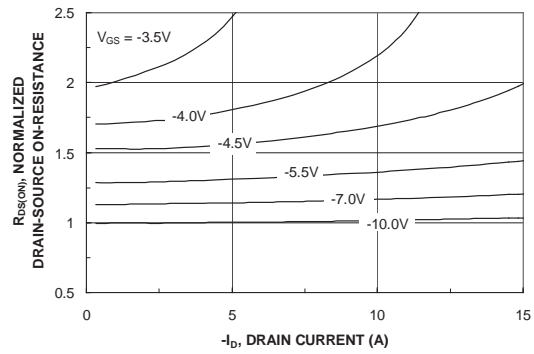


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

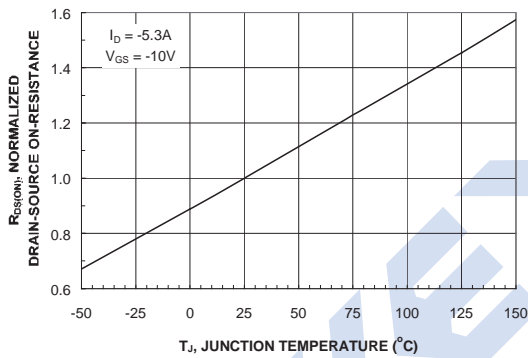


Figure 3. On-Resistance Variation with Temperature.

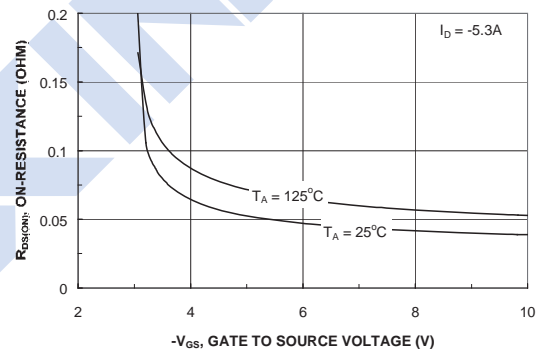


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

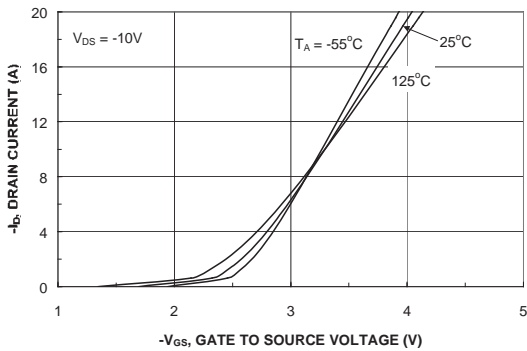


Figure 5. Transfer Characteristics.

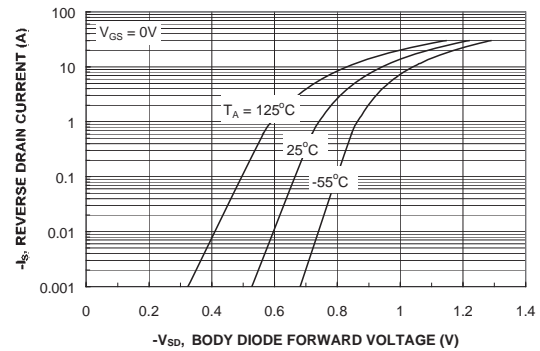


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

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Typical Characteristics

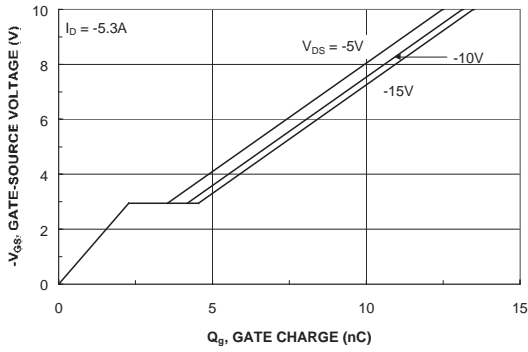


Figure 7. Gate Charge Characteristics.

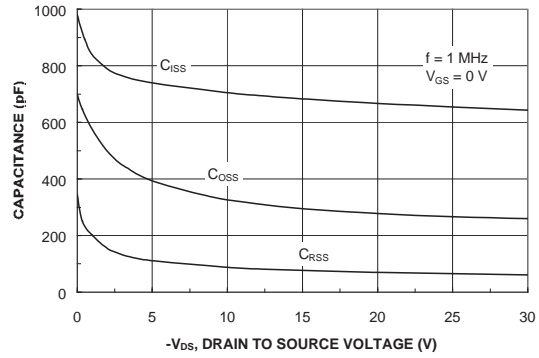


Figure 8. Capacitance Characteristics.

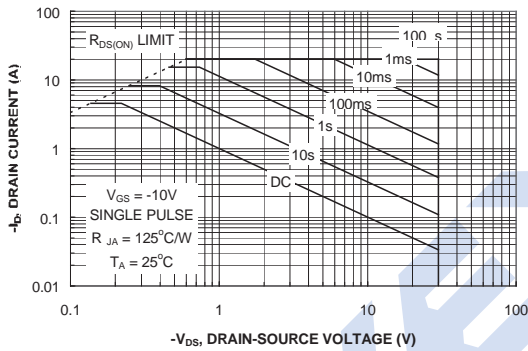


Figure 9. Maximum Safe Operating Area.

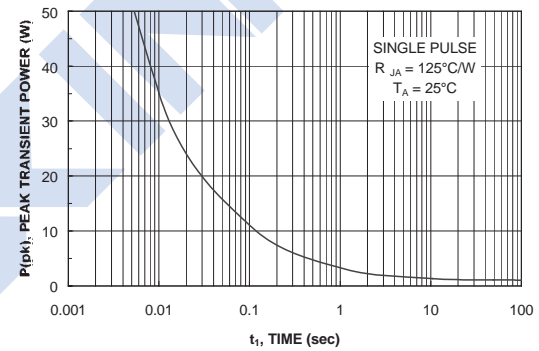


Figure 10. Single Pulse Maximum Power Dissipation.

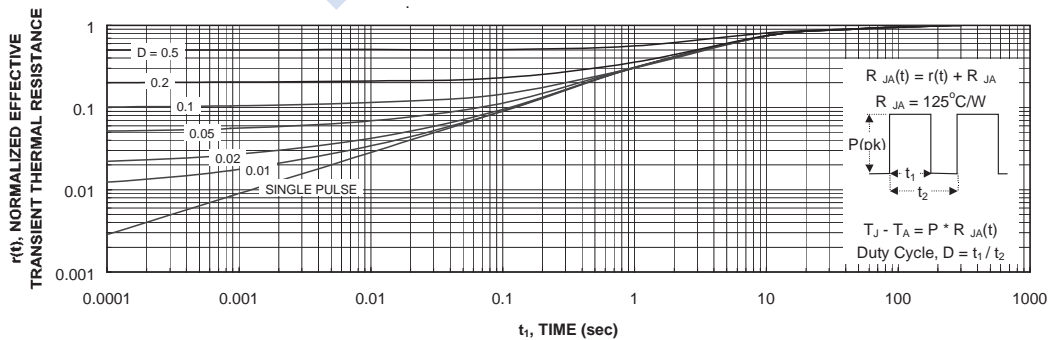


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c.
Transient thermal response will change depending on the circuit board design.